High Performance BGA Cooling Solutions w/ Thermal Tape Attachment





ATS Part#: ATS-54170K-C1-R0

Description: High Performance Extrusion, T412, BLACK-ANODIZED

Heat Sink Type: Straight Fin
Heat Sink Attachment: THERMAL TAPE
Equivalent Part Number: ATS-54170K-C2-R0

*Image above is for illustration purpose only.

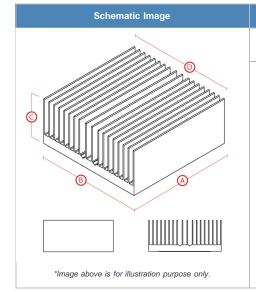
Features & Benefits

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- Designed specifically for BGAs and other surface mount packages
- · Comes pre-assembled with high performance thermal interface material

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	13.10 °C/W	10.43 °C/W	9.02 °C/W	8.09 °C/W	7.41 °C/W	6.90 °C/W	6.48 °C/W
	Ducted Flow	7.80	n/a	n/a	n/a	n/a	n/a	n/a

Product Detail



Dimension A	Dimension B	Dimension C	Dimension D	TIM	Finish
17.0 mm	17.0 mm	14.5 mm	mm	T412	BLACK-ANODIZED

Notes:

- Dimension A and B refer to component size.
- Dimension C is the heat sink height from the bottom of the base to the top of the fin field.
- ATS-54170K-C2-R0 is the exact heat sink assembly with an equivalent thermal interface material (Saint Gobain C675).
- Thermal performance data are provided for reference only. Actual performance may vary by application.
- ATS reserves the right to update or change its products without notice to improve the design or performance.
- ATS certifies that this heat sink assembly is RoHS-6 and REACH compliant.
- Contact ATS to learn about custom options available.

